


 WN-2631  
 2002-318271

UNITED STATES

## DECLARATION FOR PATENT APPLICATION

Docket No. \_\_\_\_\_

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## MEMORY MODULE, MEMORY CHIP, AND MEMORY SYSTEM

the specification of which

(check one) ☐ is attached hereto  
☒ was filed on 10/31/2003 as  
 Application Serial No. 10/699,628  
 and was amended on \_\_\_\_\_ (if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application (s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

## Prior Foreign Application (s)

|                                |                           |   | Priority Claimed |                |
|--------------------------------|---------------------------|---|------------------|----------------|
|                                |                           |   | yes              | no             |
| <u>318271/2002</u><br>(Number) | <u>Japan</u><br>(Country) | <u>31/10/2002</u><br>(Day/Month/Year Filed) | yes              | <del>xxx</del> |
| _____<br>(Number)              | _____<br>(Country)        | _____<br>(Day/Month/Year Filed)             | yes              | no             |
| _____<br>(Number)              | _____<br>(Country)        | _____<br>(Day/Month/Year Filed)             | yes              | no             |


I hereby declare the benefit under title 35, United States Code §120 of any United States application (s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in title 37, Code of Federal regulations §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:


| (Application Serial No.)          | (Filing Date)          | (States-patented, pending, abandoned)          |
|-----------------------------------|------------------------|--|
| _____<br>(Application Serial No.) | _____<br>(Filing Date) | _____<br>(States-patented, pending, abandoned) |

I hereby appoint as my attorney and agent Aaron B. Karas, Reg. No. 18,923, Samson Helfgott, Reg. No. 23,072, Linda S. Chan, Reg. No. 42,400, Michael Markowitz, Reg. No. 30,659, Brian Myers, Reg. No. 46,947, Harris Wolin, Reg. No. 39,432, Shahnn Islam, Reg. No. 32,507, Emma Shleifer, Reg. No. 29,734, Serle Mosoff, Reg. No. 25,900, and Thomas J. Bean, Reg. No. 44,528 to prosecute this application and to transmit all business in the Patent and Trademark Office connected therewith.

Address all correspondence to:

 Katten Muchin Zavis Rosenman  
 575 Madison Avenue  
 New York, New York 10022-2585  
 Telephone No.: (212) 940-8800

Full name of sole or first inventor Seiji FUNABA  
Inventor's signature *Seiji Funaba*  Date June 29, 2004  
Residence Tokyo, Japan Citizenship Japanese  
Post Office Address c/o Elpida Memory, Inc., 2-1, Yaesu 2-chome, Chuo-ku, Tokyo, Japan

Full name of second inventor Yoji NISHIO  
Inventor's signature *Yoji Nishio*  Date June 29, 2004  
Residence Tokyo, Japan Citizenship Japanese  
Post Office Address c/o Elpida Memory, Inc., 2-1, Yaesu 2-chome, Chuo-ku, Tokyo, Japan

Full name of third inventor \_\_\_\_\_  
Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_ Citizenship \_\_\_\_\_  
Post Office Address \_\_\_\_\_

Full name of fourth inventor \_\_\_\_\_  
Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_ Citizenship \_\_\_\_\_  
Post Office Address \_\_\_\_\_

Full name of fifth inventor \_\_\_\_\_  
Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_ Citizenship \_\_\_\_\_  
Post Office Address \_\_\_\_\_

Full name of sixth inventor \_\_\_\_\_  
Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_ Citizenship \_\_\_\_\_  
Post Office Address \_\_\_\_\_